

- 2-V to 5.5-V  $V_{CC}$  Operation
- Supports Mixed-Mode Voltage Operation on All Ports
- High On-Off Output-Voltage Ratio
- Low Crosstalk Between Switches
- Individual Switch Controls
- Extremely Low Input Current
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

## description/ordering information

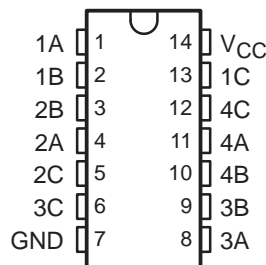
This quadruple silicon-gate CMOS analog switch is designed for 2-V to 5.5-V  $V_{CC}$  operation.

This switch is designed to handle both analog and digital signals. Each switch permits signals with amplitudes up to 5.5 V (peak) to be transmitted in either direction.

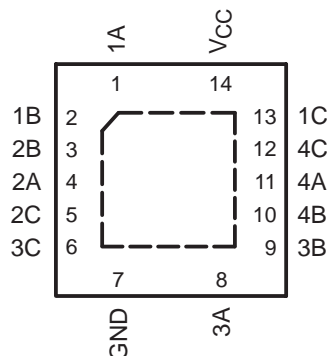
Each switch section has its own enable-input control (C). A high-level voltage applied to C turns on the associated switch section.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

D, DB, DGV, N, NS, OR PW PACKAGE  
(TOP VIEW)



RGY PACKAGE  
(TOP VIEW)



NC – No internal connection

## ORDERING INFORMATION

| $T_A$         | PACKAGE†    |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|-------------|---------------|-----------------------|------------------|
| –40°C to 85°C | PDIP – N    | Tube          | SN74AHC4066N          | SN74AHC4066N     |
|               | QFN – RGY   | Tape and reel | SN74AHC4066RGYR       | HA4066           |
|               | SOIC – D    | Tube          | SN74AHC4066D          | AHC4066          |
|               |             | Tape and reel | SN74AHC4066DR         |                  |
|               | SOP – NS    | Tube          | SN74AHC4066NS         | AHC4066          |
|               |             | Tape and reel | SN74AHC4066NSR        |                  |
|               | SSOP – DB   | Tube          | SN74AHC4066DB         | HA4066           |
|               |             | Tape and reel | SN74AHC4066DBR        |                  |
|               | TSSOP – PW  | Tube          | SN74AHC4066PW         | HA4066           |
|               |             | Tape and reel | SN74AHC4066PWR        |                  |
|               | TVSOP – DGV | Tape and reel | SN74AHC4066DGV        | HA4066           |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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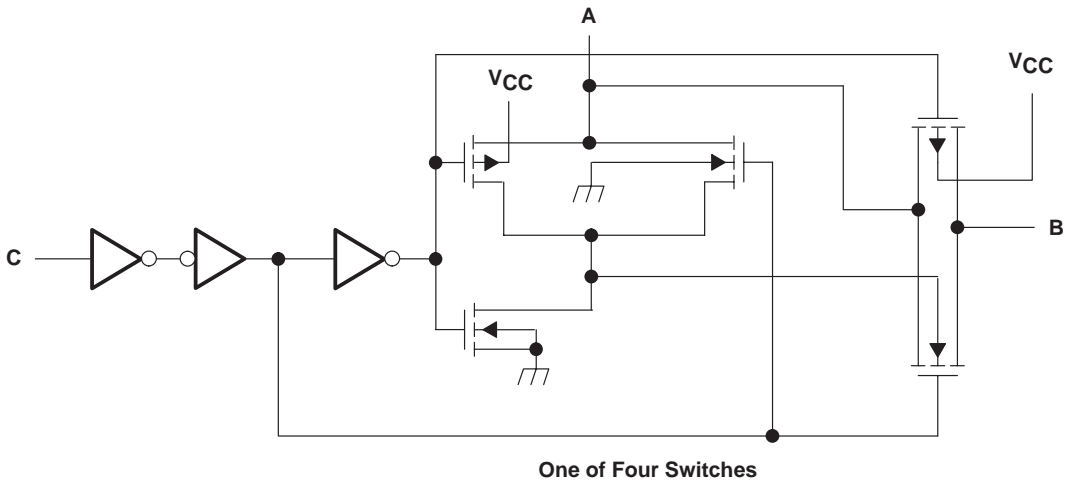
SN74AHC4066  
QUADRUPLE BILATERAL ANALOG SWITCH

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FUNCTION TABLE  
(each switch)

| INPUT CONTROL (C) | SWITCH |
|-------------------|--------|
| L                 | OFF    |
| H                 | ON     |

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

|  |                            |
|--|----------------------------|
| Supply voltage range, $V_{CC}$ (see Note 1)                        | –0.5 V to 7 V              |
| Input voltage range, $V_I$ (see Note 1)                            | –0.5 V to 7 V              |
| Switch I/O voltage range, $V_{IO}$ (see Notes 1 and 2)             | –0.5 V to $V_{CC} + 0.5$ V |
| Control-input clamp current, $I_{IK}$ ( $V_I < 0$ )                | –20 mA                     |
| I/O diode current, $I_{IOK}$ ( $V_{IO} < 0$ or $V_{IO} > V_{CC}$ ) | ±50 mA                     |
| On-state switch current, $I_T$ ( $V_{IO} = 0$ to $V_{CC}$ )        | ±25 mA                     |
| Continuous current through $V_{CC}$ or GND                         | ±50 mA                     |
| Package thermal impedance, $\theta_{JA}$ (see Note 3): D package   | 86°C/W                     |
| (see Note 3): DB package   | 96°C/W                     |
| (see Note 3): DGV package  | 127°C/W                    |
| (see Note 3): N package  | 80°C/W                     |
| (see Note 3): NS package   | 76°C/W                     |
| (see Note 3): PW package   | 113°C/W                    |
| (see Note 4): RGY package  | 47°C/W                     |
| Storage temperature range, $T_{stg}$                               | –65°C to 150°C             |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. This value is limited to 5.5 V maximum.

3. The package thermal impedance is calculated in accordance with JESD 51-7.

4. The package thermal impedance is calculated in accordance with JESD 51-5.

**recommended operating conditions (see Note 5)**

|                 |  | MIN                              | MAX                   | UNIT |
|-----------------|--|----------------------------------|-----------------------|------|
| V <sub>CC</sub> | Supply voltage                           | 2†                               | 5.5                   | V    |
| V <sub>IH</sub> | High-level input voltage, control inputs | V <sub>CC</sub> = 2 V            | 1.5                   | V    |
|                 |  | V <sub>CC</sub> = 2.3 V to 2.7 V | V <sub>CC</sub> × 0.7 |      |
|                 |  | V <sub>CC</sub> = 3 V to 3.6 V   | V <sub>CC</sub> × 0.7 |      |
|                 |  | V <sub>CC</sub> = 4.5 V to 5.5 V | V <sub>CC</sub> × 0.7 |      |
| V <sub>IL</sub> | Low-level input voltage, control inputs  | V <sub>CC</sub> = 2 V            | 0.5                   | V    |
|                 |  | V <sub>CC</sub> = 2.3 V to 2.7 V | V <sub>CC</sub> × 0.3 |      |
|                 |  | V <sub>CC</sub> = 3 V to 3.6 V   | V <sub>CC</sub> × 0.3 |      |
|                 |  | V <sub>CC</sub> = 4.5 V to 5.5 V | V <sub>CC</sub> × 0.3 |      |
| V <sub>I</sub>  | Control input voltage                    | 0                                | 5.5                   | V    |
| V <sub>IO</sub> | Input/output voltage                     | 0                                | V <sub>CC</sub>       | V    |
| Δt/Δv           | Input transition rise or fall rate       | V <sub>CC</sub> = 2.3 V to 2.7 V | 200                   | ns/V |
|                 |  | V <sub>CC</sub> = 3 V to 3.6 V   | 100                   |      |
|                 |  | V <sub>CC</sub> = 4.5 V to 5.5 V | 20                    |      |
| T <sub>A</sub>  | Operating free-air temperature           | –40                              | 85                    | °C   |

† With supply voltages at or near 2 V, the analog switch on-state resistance becomes very nonlinear. Only digital signals should be transmitted at these low supply voltages.

NOTE 5: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN74AHC4066

## QUADRUPLE BILATERAL ANALOG SWITCH

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER   | TEST CONDITIONS   | V <sub>CC</sub> | T <sub>A</sub> = 25°C |     |      | MIN | MAX | UNIT |
|---|---|-----------------|-----------------------|-----|------|-----|-----|------|
|   |   |                 | MIN                   | TYP | MAX  |     |     |      |
| r <sub>on</sub> On-state switch resistance                          | I <sub>T</sub> = –1 mA,<br>V <sub>I</sub> = V <sub>CC</sub> or GND,<br>V <sub>C</sub> = V <sub>IH</sub><br>(see Figure 1)   | 2.3 V           |                       | 38  | 180  |     | 225 | Ω    |
|   |   | 3 V             |                       | 29  | 150  |     | 190 |      |
|   |   | 4.5 V           |                       | 21  | 75   |     | 100 |      |
| r <sub>on(p)</sub> Peak on-state resistance                         | I <sub>T</sub> = –1 mA,<br>V <sub>I</sub> = V <sub>CC</sub> to GND,<br>V <sub>C</sub> = V <sub>IH</sub>   | 2.3 V           |                       | 143 | 500  |     | 600 | Ω    |
|   |   | 3 V             |                       | 57  | 180  |     | 225 |      |
|   |   | 4.5 V           |                       | 31  | 100  |     | 125 |      |
| Δr <sub>on</sub> Difference in on-state resistance between switches | I <sub>T</sub> = –1 mA,<br>V <sub>I</sub> = V <sub>CC</sub> to GND,<br>V <sub>C</sub> = V <sub>IH</sub>   | 2.3 V           |                       | 6   | 30   |     | 40  | Ω    |
|   |   | 3 V             |                       | 3   | 20   |     | 30  |      |
|   |   | 4.5 V           |                       | 2   | 15   |     | 20  |      |
| I <sub>I</sub> Control input current                                | V <sub>I</sub> = 5.5 V or GND   | 0 to 5.5 V      |                       |     | ±0.1 |     | ±1  | μA   |
| I <sub>S(off)</sub> Off-state switch leakage current                | V <sub>I</sub> = V <sub>CC</sub> and V <sub>O</sub> = GND, or V <sub>I</sub> = GND and V <sub>O</sub> = V <sub>CC</sub> ,<br>V <sub>C</sub> = V <sub>IL</sub><br>(see Figure 2) | 5.5 V           |                       |     | ±0.1 |     | ±1  | μA   |
| I <sub>S(on)</sub> On-state switch leakage current                  | V <sub>I</sub> = V <sub>CC</sub> or GND,<br>V <sub>C</sub> = V <sub>IH</sub><br>(see Figure 3)  | 5.5 V           |                       |     | ±0.1 |     | ±1  | μA   |
| I <sub>CC</sub> Supply current                                      | V <sub>I</sub> = V <sub>CC</sub> or GND   | 5.5 V           |                       |     |      |     | 20  | μA   |
| C <sub>ic</sub> Control input capacitance                           |   |                 |                       | 1.5 |      |     |     | pF   |
| C <sub>io</sub> Switch input/output capacitance                     |   |                 |                       | 5.5 |      |     |     | pF   |
| C <sub>F</sub> Feed-through capacitance                             |   |                 |                       | 0.5 |      |     |     | pF   |

**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 2.5 V ± 0.2 V (unless otherwise noted)**

| PARAMETER   | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST<br>CONDITIONS   | T <sub>A</sub> = 25°C |     |     | MIN | MAX | UNIT |
|---|-----------------|----------------|--|-----------------------|-----|-----|-----|-----|------|
|   |                 |                |  | MIN                   | TYP | MAX |     |     |      |
| t <sub>PLH</sub><br>t <sub>PHL</sub> Propagation delay time | A or B          | B or A         | C <sub>L</sub> = 15 pF,<br>(see Figure 4)                          |                       | 1.2 | 10  |     | 16  | ns   |
| t <sub>PZH</sub><br>t <sub>PZL</sub> Switch turn-on time    | C               | A or B         | C <sub>L</sub> = 15 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) |                       | 3.3 | 15  |     | 20  | ns   |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> Switch turn-off time   | C               | A or B         | C <sub>L</sub> = 15 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) |                       | 6   | 15  |     | 23  | ns   |
| t <sub>PLH</sub><br>t <sub>PHL</sub> Propagation delay time | A or B          | B or A         | C <sub>L</sub> = 50 pF,<br>(see Figure 4)                          |                       | 2.6 | 12  |     | 18  | ns   |
| t <sub>PZH</sub><br>t <sub>PZL</sub> Switch turn-on time    | C               | A or B         | C <sub>L</sub> = 50 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) |                       | 4.2 | 25  |     | 32  | ns   |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> Switch turn-off time   | C               | A or B         | C <sub>L</sub> = 50 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) |                       | 9.6 | 25  |     | 32  | ns   |

**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted)**

| PARAMETER   | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST<br>CONDITIONS   | T <sub>A</sub> = 25°C |     |     | MIN | MAX | UNIT |
|---|-----------------|----------------|--|-----------------------|-----|-----|-----|-----|------|
|   |                 |                |  | MIN                   | TYP | MAX |     |     |      |
| t <sub>PLH</sub><br>t <sub>PHL</sub> Propagation delay time | A or B          | B or A         | C <sub>L</sub> = 15 pF,<br>(see Figure 4)                          |                       | 0.8 | 6   |     | 10  | ns   |
| t <sub>PZH</sub><br>t <sub>PZL</sub> Switch turn-on time    | C               | A or B         | C <sub>L</sub> = 15 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) |                       | 2.3 | 11  |     | 15  | ns   |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> Switch turn-off time   | C               | A or B         | C <sub>L</sub> = 15 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) |                       | 4.5 | 11  |     | 15  | ns   |
| t <sub>PLH</sub><br>t <sub>PHL</sub> Propagation delay time | A or B          | B or A         | C <sub>L</sub> = 50 pF,<br>(see Figure 4)                          |                       | 1.5 | 9   |     | 12  | ns   |
| t <sub>PZH</sub><br>t <sub>PZL</sub> Switch turn-on time    | C               | A or B         | C <sub>L</sub> = 50 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) |                       | 3   | 18  |     | 22  | ns   |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> Switch turn-off time   | C               | A or B         | C <sub>L</sub> = 50 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) |                       | 7.2 | 18  |     | 22  | ns   |

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## QUADRUPLE BILATERAL ANALOG SWITCH

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**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 5 V ± 0.5 V (unless otherwise noted)**

| PARAMETER                            | FROM<br>(INPUT)           | TO<br>(OUTPUT) | TEST<br>CONDITIONS | T <sub>A</sub> = 25°C  |     |     | MIN | MAX | UNIT |
|--------------------------------------|---------------------------|----------------|--------------------|--|-----|-----|-----|-----|------|
|                                      |                           |                |                    | MIN  | TYP | MAX |     |     |      |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation<br>delay time | A or B         | B or A             | C <sub>L</sub> = 15 pF,<br>(see Figure 4)                          | 0.3 | 4   |     | 7   | ns   |
| t <sub>PZH</sub><br>t <sub>PZL</sub> | Switch<br>turn-on time    | C              | A or B             | C <sub>L</sub> = 15 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) | 1.6 | 7   |     | 10  | ns   |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> | Switch<br>turn-off time   | C              | A or B             | C <sub>L</sub> = 15 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) | 3.2 | 7   |     | 10  | ns   |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation<br>delay time | A or B         | B or A             | C <sub>L</sub> = 50 pF,<br>(see Figure 4)                          | 0.6 | 6   |     | 8   | ns   |
| t <sub>PZH</sub><br>t <sub>PZL</sub> | Switch<br>turn-on time    | C              | A or B             | C <sub>L</sub> = 50 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) | 2.1 | 12  |     | 16  | ns   |
| t <sub>PLZ</sub><br>t <sub>PHZ</sub> | Switch<br>turn-off time   | C              | A or B             | C <sub>L</sub> = 50 pF,<br>R <sub>L</sub> = 1 kΩ<br>(see Figure 5) | 5.1 | 12  |     | 16  | ns   |

**analog switch characteristics over operating free-air temperature range (unless otherwise noted)**

| PARAMETER  | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST<br>CONDITIONS   | V <sub>CC</sub>                       | T <sub>A</sub> = 25°C |     |     | UNIT |
|--|-----------------|----------------|--|---------------------------------------|-----------------------|-----|-----|------|
|  |                 |                |  |                                       | MIN                   | TYP | MAX |      |
| Frequency response<br>(switch on)                | A or B          | B or A         | C <sub>L</sub> = 50 pF, R <sub>L</sub> = 600 Ω,<br>f <sub>in</sub> = 1 MHz (sine wave)<br>20log <sub>10</sub> (V <sub>O</sub> /V <sub>I</sub> ) = -3 dB (see Figure 6) | 2.3 V                                 |                       | 30  |     | MHz  |
|  |                 |                |  | 3 V                                   |                       | 35  |     |      |
|  |                 |                |  | 4.5 V                                 |                       | 50  |     |      |
| Crosstalk<br>(between any switches)              | A or B          | B or A         | C <sub>L</sub> = 50 pF, R <sub>L</sub> = 600 Ω,<br>f <sub>in</sub> = 1 MHz (sine wave) (see Figure 7)  | 2.3 V                                 |                       | -45 |     | dB   |
|  |                 |                |  | 3 V                                   |                       | -45 |     |      |
|  |                 |                |  | 4.5 V                                 |                       | -45 |     |      |
| Crosstalk<br>(control input to<br>signal output) | C               | A or B         | C <sub>L</sub> = 50 pF, R <sub>L</sub> = 600 Ω,<br>f <sub>in</sub> = 1 MHz (square wave) (see Figure 8)  | 2.3 V                                 |                       | 15  |     | mV   |
|  |                 |                |  | 3 V                                   |                       | 20  |     |      |
|  |                 |                |  | 4.5 V                                 |                       | 50  |     |      |
| Feed-through attenuation<br>(switch off)         | A or B          | B or A         | C <sub>L</sub> = 50 pF, R <sub>L</sub> = 600 Ω, f <sub>in</sub> = 1 MHz<br>(see Figure 9)  | 2.3 V                                 |                       | -40 |     | dB   |
|  |                 |                |  | 3 V                                   |                       | -40 |     |      |
|  |                 |                |  | 4.5 V                                 |                       | -40 |     |      |
| Sine-wave distortion                             | A or B          | B or A         | C <sub>L</sub> = 50 pF, R <sub>L</sub> = 10 kΩ,<br>f <sub>in</sub> = 1 kHz (sine wave)<br>(see Figure 10)  | V <sub>I</sub> = 2 V <sub>p-p</sub>   | 2.3 V                 |     | 0.1 | %    |
|  |                 |                |  | V <sub>I</sub> = 2.5 V <sub>p-p</sub> | 3 V                   |     | 0.1 |      |
|  |                 |                |  | V <sub>I</sub> = 4 V <sub>p-p</sub>   | 4.5 V                 |     | 0.1 |      |

**operating characteristics, T<sub>A</sub> = 25°C**

| PARAMETER                                     | TEST CONDITIONS                    | TYP | UNIT |
|---|------------------------------------|-----|------|
| C <sub>pd</sub> Power dissipation capacitance | C <sub>L</sub> = 50 pF, f = 10 MHz | 4.5 | pF   |



PARAMETER MEASUREMENT INFORMATION

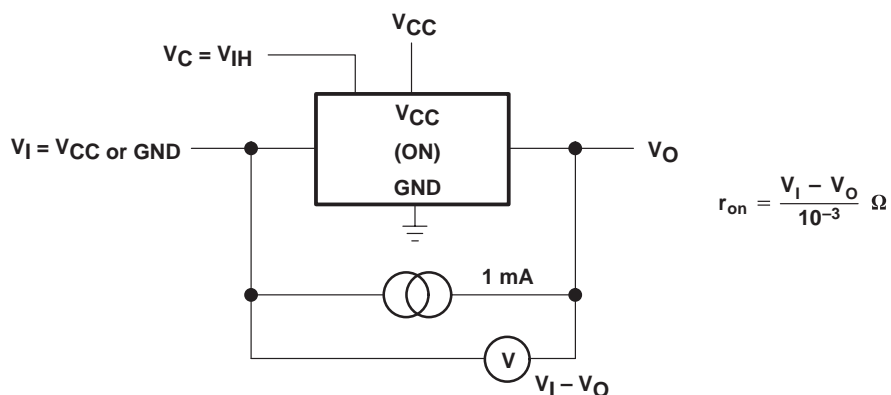


Figure 1. On-State Resistance Test Circuit

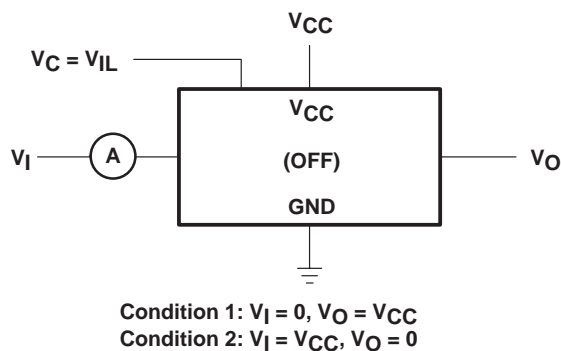


Figure 2. Off-State Switch Leakage-Current Test Circuit

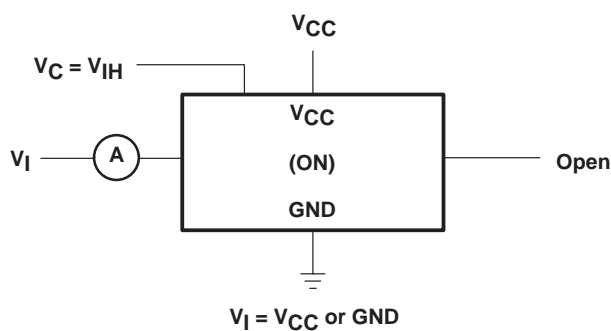


Figure 3. On-State Leakage-Current Test Circuit

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PARAMETER MEASUREMENT INFORMATION

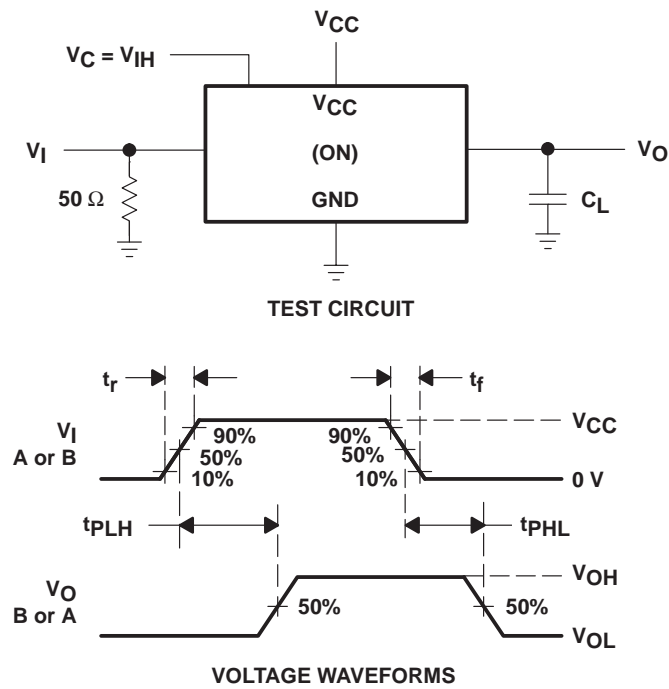
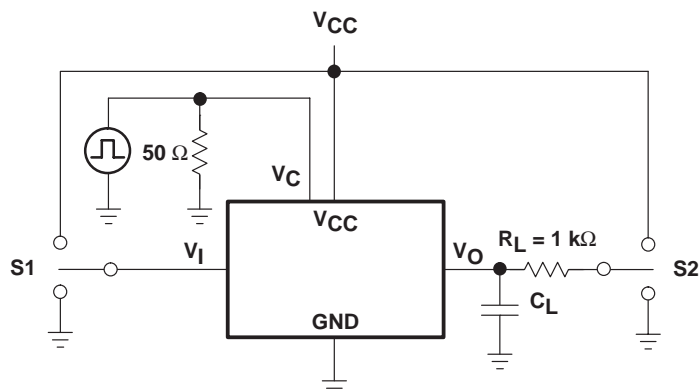


Figure 4. Propagation Delay Time, Signal Input to Signal Output

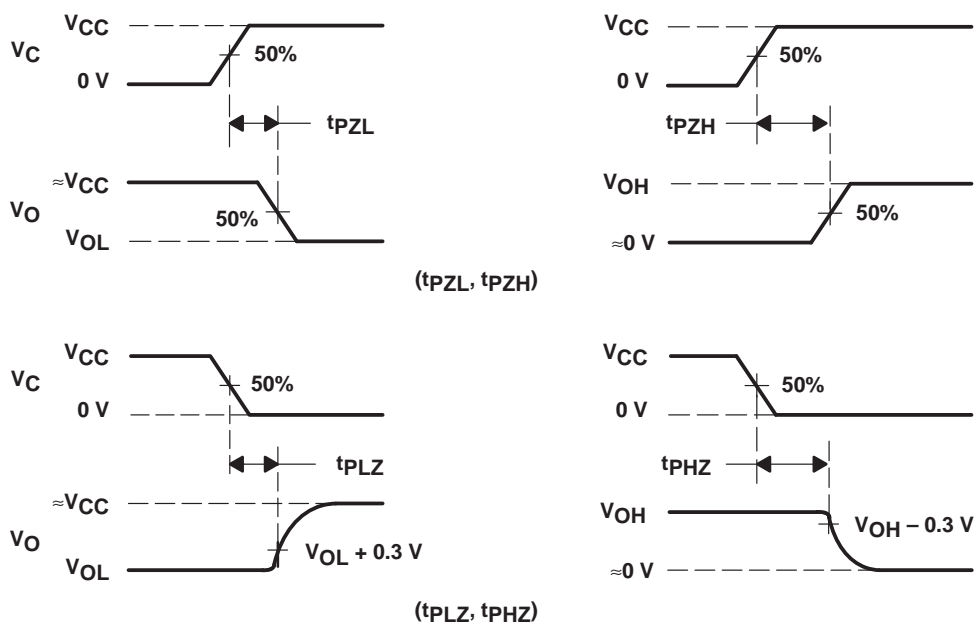


PARAMETER MEASUREMENT INFORMATION



| TEST      | S1       | S2       |
|-----------|----------|----------|
| $t_{PZL}$ | GND      | $V_{CC}$ |
| $t_{PZH}$ | $V_{CC}$ | GND      |
| $t_{PLZ}$ | GND      | $V_{CC}$ |
| $t_{PHZ}$ | $V_{CC}$ | GND      |

TEST CIRCUIT



VOLTAGE WAVEFORMS

Figure 5. Switching Time ( $t_{PZL}$ ,  $t_{PLZ}$ ,  $t_{PZH}$ ,  $t_{PHZ}$ ), Control to Signal Output

The diagram shows a CMOS inverter circuit. The input signal  $f_{in}$  is connected to the inverter's input through a  $50\ \Omega$  resistor. A  $0.1\ \mu\text{F}$  capacitor is connected between the input and the inverter's input node, which is labeled  $V_I$ . The inverter is represented by a box with  $V_{CC}$  (ON) and GND labels. The output of the inverter is connected to a load resistor  $R_L = 600\ \Omega$  and a load capacitor  $C_L = 50\ \text{pF}$ . The output node is labeled  $V_O$ . The inverter's supply voltage is  $V_{CC}$ , and its ground is GND. A note  $V_{CC}/2$  is shown near the load resistor, indicating the switching threshold.

The top circuit diagram shows a CMOS inverter with its control input  $V_C = V_{CC}$ . The input signal  $f_{in}$  is applied to the inverter's input through a  $50\ \Omega$  resistor and a  $0.1\ \mu F$  capacitor. The inverter's output  $V_{O1}$  is connected to a load resistor  $R_L = 600\ \Omega$  and a load capacitor  $C_L = 50\ pF$ . The output voltage  $V_{O1}$  is shown as a square wave. The bottom circuit diagram shows the same CMOS inverter but with its control input  $V_C = GND$ . The input signal  $f_{in}$  is applied to the inverter's input through a  $600\ \Omega$  resistor. The output  $V_{O2}$  is connected to a load resistor  $R_L = 600\ \Omega$  and a load capacitor  $C_L = 50\ pF$ . The output voltage  $V_{O2}$  is shown as a square wave. A graph of the input signal  $v_i$  is shown on the right, which is a square wave.

[illegible]

## PARAMETER MEASUREMENT INFORMATION

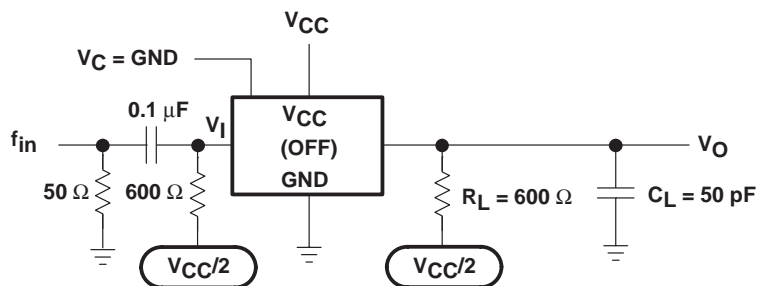


Figure 9. Feed-Through Attenuation (Switch Off)

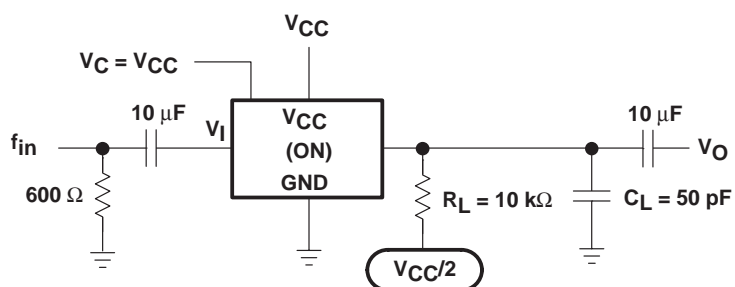


Figure 10. Sine-Wave Distortion

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup>               |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|--|
| SN74AHC4066D     | ACTIVE                | SOIC         | D               | 14   | 50          | Pb-Free (RoHS)          | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74AHC4066DBR   | ACTIVE                | SSOP         | DB              | 14   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74AHC4066DGVR  | ACTIVE                | TVSOP        | DGV             | 14   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM                         |
| SN74AHC4066DR    | ACTIVE                | SOIC         | D               | 14   | 2500        | Pb-Free (RoHS)          | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74AHC4066N     | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | Level-NC-NC-NC                             |
| SN74AHC4066NSR   | ACTIVE                | SO           | NS              | 14   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-2-260C-1 YEAR/<br>Level-1-235C-UNLIM |
| SN74AHC4066PW    | ACTIVE                | TSSOP        | PW              | 14   | 90          | Pb-Free (RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM                         |
| SN74AHC4066PWR   | ACTIVE                | TSSOP        | PW              | 14   | 2000        | Pb-Free (RoHS)          | CU NIPDAU        | Level-1-250C-UNLIM                         |
| SN74AHC4066RGYR  | ACTIVE                | QFN          | RGY             | 14   | 1000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1YEAR                         |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN



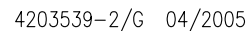
- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

## D (R-PDSO-G14)

## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-012 variation AB.



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- B. This drawing is subject to change without notice.
- C. QFN (Quad Flatpack No-Lead) package configuration.
- D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
- E. Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
- F. Package complies to JEDEC MO-241 variation BA.



# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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